

**DECLARATION AND POWER OF ATTORNEY**

As a below named inventor, I hereby declare that:

My residence, post office address, and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor of the subject matter which is claimed and for which a patent is sought on the invention entitled "SYSTEM AND METHOD FOR OPTIMIZING THE ELECTROSTATIC REMOVAL OF A WORKPIECE FRM A CHUCK," the specification of which:

is attached hereto.  
 was filed on \_\_\_\_\_ as Application Serial No. \_\_\_\_\_  
and was amended on \_\_\_\_\_ (if applicable).

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose to the Patent and Trademark Office all information known to me to be material to patentability of the subject matter claimed in this application, as "materiality" is defined in 37 C.F.R. § 1.56.

I hereby claim foreign priority benefits under 35 U.S.C. § 119(a)-(d) or § 365(b) of any foreign application(s) for patent or inventor's certificate listed below, or under § 365(a) of any PCT international application listed below designating at least one country other than the United States of America, and have identified below any foreign application for patent or inventor's certificate, or of any PCT international application, having a filing date before that of the application on which priority is claimed.

<u>Prior Foreign Application No.</u>	<u>Country</u>	<u>Filing Date</u> (mm/dd/yy)	<u>Priority</u> <u>Claimed</u>	<u>Cert. copy</u> <u>Attached</u>
N/A				

I hereby claim the benefit under 35 U.S.C. § 119(e) of any United States provisional application(s) listed below.

<u>Provisional Application No.</u>	<u>Filing Date</u> (mm/dd/yy)
N/A	

I hereby claim the benefit under 35 U.S.C. § 120 of any United States application(s) listed below, or under § 365(c) of any PCT international application listed below designating the United States of America, and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States or PCT international application in the manner provided by the first paragraph of 35 U.S.C. § 112, I acknowledge the duty to disclose all information known to me to be material to the patentability of the subject matter claimed in this application, as "materiality" is defined in 37 C.F.R. § 1.56, which became available between the filing date of the prior application and the national or PCT international filing date of this application.

<u>Parent Application No.</u>	<u>Filing Date</u> (mm/dd/yy)	<u>Parent Patent No. (if applicable) or Status</u>
N/A		

I hereby revoke any previous Powers of Attorney and appoint

Bruce R. Hopenfeld, Reg. No. 39,714; Sandeep Jaggi, Ph.D., Reg. No. 43,331; Pete P. Scott, Reg. No. 33,279; Leo J. Peters, Reg. No. 33,562 and Timothy R. Croll, Reg. No. 36,771.

*each said attorney being employed by LSI Logic Corporation; and*

Dan R. Christen, Reg. No. 39,943; Gentry E. Crook, Reg. No. 44,633; Kevin L. Daffer, Reg. No. 34,146; Mark R. DeLuca, Reg. No. 44,649; Jeffrey C. Hood, Reg. No. 35,198; Robert C. Jahnke, Reg. No. 44,800; B. Noël Kivlin, Reg. No. 33,929; Robert C. Kowert, Reg. No. 39,255; Lawrence J. Merkel, Reg. No. 41,191; Eric B. Meyertons, Reg. No. 34,876; Louise K. Miller, Reg. No. 36,609; David W. Quimby, Reg. No. 39,338; and David A. Rose, Reg. No. 26,223;

*each said attorney or agent being a member or associate of the firm of Conley, Rose & Tayon, P.C., as attorney or agent for so long as s/he remains with such company or firm, with full power of substitution and revocation, to prosecute the application, to make alterations and amendments therein, to transact all business in the Patent and Trademark Office in connection therewith, and to receive the Letters Patent.*

Please direct all communications to:

Sandeep Jaggi  
1551 McCarthy Blvd., MS D-106  
Milpitas, CA 95035

I hereby declare that all statements made herein of my own knowledge are true and that all statements made herein on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under 18 U.S.C. § 1001 and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Inventor's Full Name: Michael J. Berman

Inventor's Signature: \_\_\_\_\_ Date: \_\_\_\_\_

City and State (or Foreign Country) of Residence: Malaysia Citizenship: USA

Post Office and Residence Address: 509-16-02 Tanjong Bungah, 11200 Tanjong Bungah, Penang, Malaysia  
(Include number, street name, city, state and zip code)

Inventor's Full Name: Rennie G. Barber

Inventor's Signature: Rennie G. Barber Date: 8/13/01

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<u>Prior Foreign Application No.</u>	<u>Country</u>	<u>Filing Date</u> (mm/dd/yy)	<u>Priority</u> <u>Claimed</u>	<u>Cert. copy</u> <u>Attached</u>
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<u>Provisional Application No.</u>	<u>Filing Date</u> (mm/dd/yy)
N/A	

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Inventor's Full Name:

Michael J. Berman

Inventor's Signature:

Date: 20 Aug 2001

City and State (or Foreign Country) of Residence:

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Citizenship: USA

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Rennie G. Barber

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Date:

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